

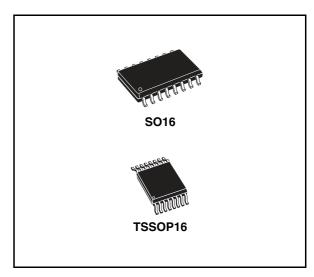
## Single chip RDS demodulator + filter

### **Features**

- Very high RDS demodulation quality with improved digital signal processing
- High performance, 57 kHz bandpass filter (8<sup>th</sup> order)
- Filter adjustment free and without external components
- Purely digitaL RDS Demodulation without external components
- ARI (SK indication) and RDS signal quality output
- 4.332 MHz crystal oscillator (8.664 and 17.328 MHz optional)
- Low noise CMOS technology
- Low radiation

### **Description**

The TDA7479 recovers the additional inaudible RDS information which is transmitted by FM radio broadcasting stations and operates in accordance with the EBU (European Broadcasting Union) specifications.



The device is made up of two sections: a cascaded antialiasing + switched capacitors 8<sup>th</sup> bandpass filter for precise RDS band selection and a demodulating section that performs the extraction od RDS data stream (RDDA) and clock (RDCL), to be further processed by a suitable RDS decoder.

Outputs for RDS signal quality and ARI indication are also present.

Table 1. Device summary

Order code	Package	Packing
E-TDA7479D <sup>(1)</sup>	SO16	Tube
E-TDA7479AD <sup>(1)</sup>	TSSOP16	Tube

<sup>1.</sup> Device in ECOPACK® package (see Section 5: Package information on page 9).

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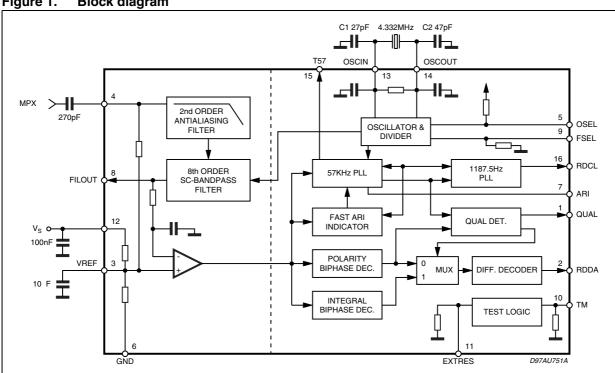
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## Block diagram and pin description

#### 1.1 **Block diagram**

Figure 1. **Block diagram** 



#### Pin description 1.2

Figure 2. Pin connection (top view)

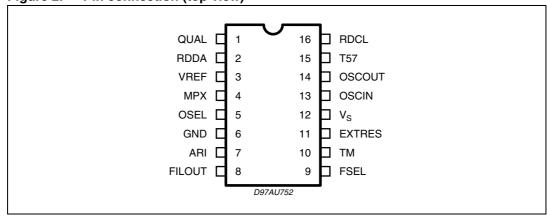


Table 2. Pin description

No pin	Name	Description				
1	QUAL	Output for signal quality indication (High = good)				
2	RDDA	RDS data output				
3	VREF	Reference voltage				
4	MPX	RDS input signal				
5	OSEL	Oscillator selector pin:  - open, closed to V <sub>S</sub> = quartz oscillator  - closed to GND = external driven				
6	GND	Ground				
7	ARI	Output for ARI indication:  - high when RDS+ARI are present  - high when only ARI is present  - low when only RDS is present  - undefined when nos signal is present				
8	FILOUT	Filter output				
9	FSEL	Frequency selector pin:  - 100 kHz to V <sub>S</sub> = 17.328 MHz  - open = 4.332MHz  - closed to VS = 8.664 MHz				
10	ТМ	Test mode pin:  - open = normal operation  - closed to VS = test mode				
11	EXTRES	Reset pin:  - open = run mode closed to VS = reset condition				
12	V <sub>S</sub>	Supply voltage				
13	OSCIN	Oscillator input				
14	OSCOUT	Oscillator output				
15	T57	Testing output pin: 57 kHz clock output				
16	RDCL	RDS clock output 1187.5 Hz				

# 2 Electrical specification

### 2.1 Thermal data

Table 3. Thermal data

Symbol	Parameter	SO16	TSSOP16	Unit
R <sub>th j-case</sub>	Thermal resistance junction to case Max.	200	160	°C/W

### 2.2 Absolute maximum ratings

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>S</sub>	Supply voltage	-0.3 to 7	V
T <sub>op</sub>	Operating temperature range	-40 to 85	°C
T <sub>stg</sub>	Storage temperature	-55 to 150	°C

### 2.3 Electrical characteristics

Table 5. Electrical characteristics

 $(T_{amb} = 25$ °C,  $V_S = 5V$ , unless otherwise specified)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
V <sub>S</sub>	Supply voltage		4.5	5	5.5	V
I <sub>S</sub>	Supply current			7.5	11.0	mA
Filter						
f <sub>C</sub>	Center frequency		56.5	57	57.5	kHz
BW	3dB Bandwidth		2.5	3	3.5	kHz
G	Gain	f = 57 kHz	18	20	22	dB
		Δf ± 4 kHz	18	22		dB
Α	Attenuation	f = 38 kHz	50	60		dB
		f = 67 kHz	35	45		dB
R <sub>I</sub>	Input impedance of MPX		80	120	150	ΚΩ
R <sub>L</sub>	Load impedance on FILOUT		1			MΩ
S/N	Signal to noise ratio	V <sub>IN</sub> = 3 mVrms	30	40		dB
V <sub>IN</sub>	MPX input signal	f = 19 kHz; T3 ≤ 40 dB <sup>(1)</sup> f = 57 kHz (RDS+ ARI)			1000 50	$\begin{array}{c} {\rm mV_{RMS}} \\ {\rm mV_{RMS}} \end{array}$
S <sub>RDS</sub>	RDS detection sensitivity		1			mVrms
S <sub>ARI</sub>	ARI Detection Sensitivity		3			mVrms

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Table 5.

Electrical characteristics (continued)  $(T_{amb} = 25$ °C,  $V_{S} = 5$ V, unless otherwise specified)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
$V_{REF}$	Reference			V <sub>S</sub> /2		V
Demodul	ator					
Input pins	,	nternal pull down resistor rnal pull up resistor				
I <sub>PD</sub>	Input current	V <sub>IN</sub> = 5 V (pull-down input)	15		30	μΑ
I <sub>PU</sub>	Input current	V <sub>IN</sub> = 0 V (pull-up input)	-25		-10	μΑ
V <sub>IH</sub>	Input voltage high		0.7 · V <sub>S</sub>	$0.8 \cdot V_{S}$		V
V <sub>IL</sub>	Input voltage low			$0.2 \cdot V_{S}$	$0.3 \cdot V_{S}$	V
Output pii	ns (RDCL, RDDA, ARI, QUAL, T57	")				
V <sub>OH</sub>	Output voltage high	I <sub>L</sub> = 0.5mA	4	4.6		V
V <sub>OL</sub>	Output voltage low	I <sub>L</sub> = 0.5mA		0.4	1	V
Oscillato	r					
V <sub>CLL</sub>	Input level OSCIN pin	OSEL = open circuit			1	V
V	Input level OSCIN pin	OSEL = open circuit	4			V
$V_{CLH}$	Amplitude OSCOUT	OSEL = open circuit		4.5		V
V <sub>PP</sub>	Amplitude OSCIN	OSEL = GND, f = 4.332 MHz OSEL = GND, f = 8.664 MHz		100 120		mVpp mVpp
	(for external drive)	OSEL = GND, f = 17.328 MHz		150		mVpp

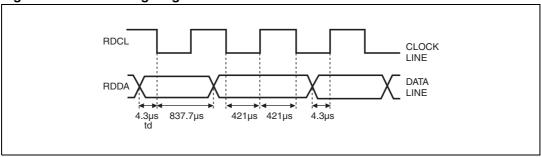
<sup>1.</sup> The 3<sup>rd</sup> harmonic (57 kHz) must be less than -40 dB with respect to the input signal plus gain.

TDA7479 Output timing

# 3 Output timing

The RDS (1187.5Hz) output clock on RDCL line is synchronized to the incoming data. According to the internal PLL lock condition data change can result on the falling or on the rising clock edge (see *Figure 3*). Whichever clock edge is used by the decoder (rising or falling edge) the data will remain valid for  $416.7 \, \mu s$  after the clock transition.





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## 4 Oscillator controls (FSEL, OSEL)

Three different crystal frequencies can be used. The adoption of the internal clock divider to the external crystal is achieved via the input pin FSEL. See the following table for reference:

Table 6. Crystal frequencies

Crystal	FSEL (pin configuration)
4.332MHz	
8.664MHz	connected to GND or open connected to Vs external resistor of 100K to Vs
17.328MHz	

A special mode is introduced to reduce EMI. With pin OSEL connected to GND the internal oscillator is switched off and an external sinusoidal frequency could be applied on OSCIN. The peak to peak voltage of this signal can be reduced down to 60mV.

In this mode the frequency selection via FSEL is still active.

Suggested values of C1 and C2 are shown in the following table:

Table 7. C1 and C2 value

Crystal	C1	C2
4.332MHz	27pF	47pF
8.664MHz	27pF	-
17.328MHz	27pF	-

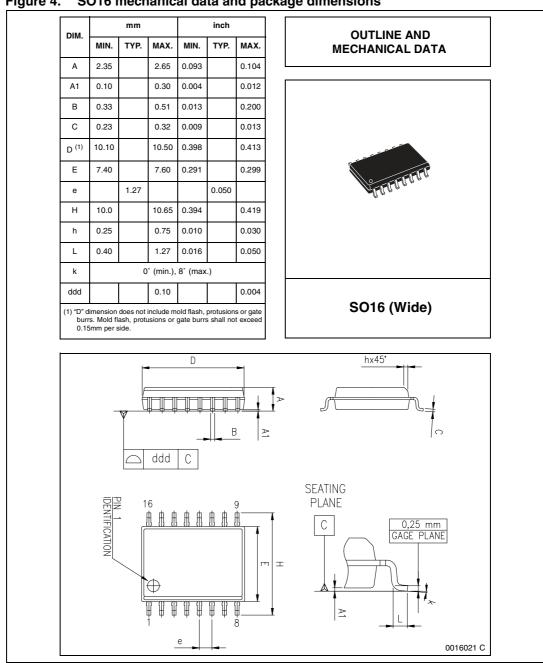
**TDA7479 Package information** 

#### 5 **Package information**

In order to meet environmental requirements, ST (also) offers these devices in ECOPACK® packages. ECOPACK® packages are lead-free. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label.

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SO16 mechanical data and package dimensions



Package information TDA7479

Figure 5. TSSOP16 mechanical data and package dimensions

DIM.	mm inch			OUTLINE AND				
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	OUTLINE AND MECHANICAL DATA	
Α			1.200			0.047		
A1	0.050		0.150	0.002		0.006		
A2	0.800	1.000	1.050	0.031	0.039	0.041		
b	0.190		0.300	0.007		0.012		
С	0.090		0.200	0.005		0.009	GRESSESSES	
D (1)	4.900	5.000	5.100	0.114	0.118	0.122	Sassin	
Е	6.200	6.400	6.600	0.244	0.252	0.260		
E1 (1)	4.300	4.400	4.500	0.170	0.173	0.177	"TOTOLIUU	
е		0.650			0.026			
L	0.450	0.600	0.750	0.018	0.024	0.030		
L1		1.000			0.039			
k		0	° (min.)	8° (max	.)			
aaa			0.100			0.004	TSSOP16	
Note: 1. D and E1 does not include mold flash or protrusions.  Mold flash or potrusions shall not exceed 0.15mm (.006inch) per side.  (Body 4.4mm)								
			aga	D	b	A	E1 Co	
<u>10</u>	PIN 1 ENTIFIC <i>ê</i>	ATION	aaa		9	-	_	

TDA7479 Revision history

# 6 Revision history

Table 8. Document revision history

Date	Revision	Changes
10-Sep-2004	4	Initial release.
20-Nov-2004	5	Add in <i>Table 5: Electrical characteristics on page 5</i> the "RDS and ARI Detection Sensitivity" parameters.
02-Dec-2004	6	Modified the order codes table.
04-Nov-2008	7	Document reformatted. Updated Table 1: Device summary on page 1. Updated Section 5: Package information on page 9.
16-Sept-2013	8	Updated Disclaimer

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